Notice of References Cited

Application/Control No.

O9/955,926

Examiner

Thomas J. Magee

Applicant(s)/Patent Under
Reexamination
MALLARDEAU ET AL.

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U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	Α	US-6,492,241 B1	12-2002	Howard E. Rhodes et al.	438/386
	В	US-6,358,820 B1	03-2002	Shigenobu Maeda	438/459
	С	US-6,133,599	10-2000	Jan Mye Sung et al.	257/296
	D	US-6,294,464 B1	09-2001	Jigish D. Trivedi	
	E	US-			
	F	US-			
	G	US-			
	н	US-			
	ı	US-			
	J	US-			
	К	US-			
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FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					·
	0					
	Ρ					·
	Q			,		
	R					
	S					
	Т					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Syd. R. Wilson, Clarence J. Tracy, and John L. Freeman, Jr., "Handbook of Multilevel Metallization for Integrated Circuits," Noyes Publ., Westwood, New Jersey (1993), pp. 82-84,157,868.
	V	S. Wolf, ""Silicon Processing for the VLSI Era: Volume 2 - Process Integration," Lattice Press, Sunset Beach, CA (1990), pp.12-13.
	w	
	x	

*A copy of this reference is not being furnished with this Office action. (See MREP § 707.05(a).)

Dates in MM-YYYY format are publication dates. Classifications may be US or location.

U.S. Patent and Trademark Office PTO-892 (Rev. 01-2001)

Notice of References Cited

Part of Paper No. 11





Notice of References Cited

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Application/Control No. 09/955,926	Reexamination	Applicant(s)/Patent Under Reexamination MALLARDEAU ET AL.		
Examiner	Art Unit			
Thomas J. Magee	2811	Page 1 of 1		

U.S. PATENT DOCUMENTS

				U.S. PATEINT DOCUMENTS	
*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	Α	US-6,492,241 B1	12-2002	Howard E. Rhodes et al.	438/386
	В	US-6,358,820 B1	03-2002	Shigenobu Maeda	438/459
	С	US-6,133,599	10-2000	Jan Mye Sung et al.	257/296
	D	US-6,294,464 B1	09-2001	Jigish D. Trivedi	438/649
	Е	US-5,959,327	09-1999	Gurtej S. Sandhu et al.	257/310
	F	US-			
	G	US-			
	Н	US-			
	ı	US-			
	J	US-			
	к	US-			
	L	US-			
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FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
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	Т					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Syd. R. Wilson, Clarence J. Tracy, and John L. Freeman, Jr., "Handbook of Multilevel Metallization for Integrated Circuits," Noyes Publ., Westwood, New Jersey (1993), pp. 82-84,157,868.
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	w	
	х	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).) Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.